

BULD118D-1

HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- INTEGRATED ANTIPARALLEL COLLECTOR- EMITTER DIODE
- HIGH VOLTAGE CAPABILITY
- LOW SPREAD OF DYNAMIC PARAMETERS
- MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- VERY HIGH SWITCHING SPEED

APPLICATIONS:

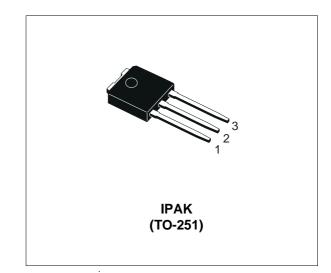
- ELECTRONIC BALLASTS FOR FLUORESCENT LIGHTING
- FLYBACK AND FORWARD SINGLE TRANSISTOR LOW POWER CONVERTERS

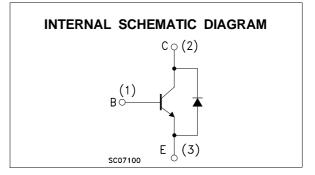
DESCRIPTION

The device is manufactured using high voltage Multi Epitaxial Planar technology for high switching speeds and medium voltage capability.

It uses a Cellular Emitter structure with planar edge termination to enhance switching speeds while maintaining the wide RBSOA.

The device is designed for use in lighting applications and low cost switch-mode power supplies.





ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
|------------------|---|------------|------|
| VCES | Collector-Emitter Voltage (V _{BE} = 0) | 700 | V |
| VCEO | Collector-Emitter Voltage ($I_B = 0$) | 400 | V |
| V _{EBO} | Emitter-Base Voltage $(I_C = 0)$ | 9 | V |
| Ιc | Collector Current | 2 | A |
| I _{CM} | Collector Peak Current (t _p < 5 ms) | 4 | A |
| Ι _Β | Base Current | 1 | А |
| I _{BM} | Base Peak Current (t _p < 5 ms) | 2 | А |
| P _{tot} | Total Dissipation at $T_c = 25 \ ^{\circ}C$ | 20 | W |
| T _{stg} | Storage Temperature | -65 to 150 | °C |
| Tj | Max. Operating Junction Temperature | 150 | °C |

THERMAL DATA

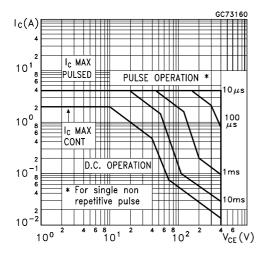
| R _{thj-case} | Thermal Resistance | Junction-Case | Max | 6.25 | °C/W |
|-----------------------|--------------------|------------------|-----|------|------|
| $R_{thj-amb}$ | Thermal Resistance | Junction-Ambient | Max | 100 | °C/W |

ELECTRICAL CHARACTERISTICS ($T_{case} = 25 \ ^{\circ}C$ unless otherwise specified)

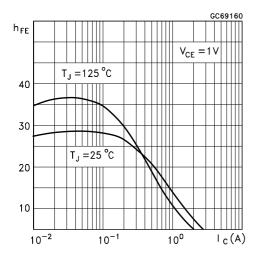
| Symbol | Parameter | Test Co | Min. | Тур. | Max. | Unit | |
|----------------------------------|--|---|---|---------------|-------------|--------------------|----------------------|
| ICES | Collector Cut-off Current (V _{BE} = 0) | V _{CE} = 700 V V _{CE} = 700 V | T _j = 125 °C | | | 100 500 | μΑ μΑ |
| V _{EBO} | Emitter-Base Voltage | I _E = 10 mA | | 9 | | | V |
| $V_{CEO(sus)}$ | Collector-Emitter Sustaining Voltage | I _C = 100 mA | L = 25 mH | 400 | | | V |
| I _{CEO} | Collector-Emitter Leakage Current | V _{CE} = 400 V | | | | 250 | μA |
| V _{CE(sat)} * | Collector-Emitter Saturation Voltage | $I_{C} = 0.5 A$ $I_{C} = 1 A$ $I_{C} = 2 A$ | $I_{B} = 0.1 A$ $I_{B} = 0.2 A$ $I_{B} = 0.4 A$ | | | 0.5 1 1.5 | V V V |
| V _{BE(sat)} * | Base-Emitter Saturation Voltage | $I_{C} = 0.5 A$ $I_{C} = 1 A$ $I_{C} = 2 A$ | $I_{B} = 0.1 A$ $I_{B} = 0.2 A$ $I_{B} = 0.4 A$ | | | 1.0 1.2 1.3 | V V V |
| h _{FE} * | DC Current Gain | $I_{C} = 10 \text{ mA}$ $I_{C} = 0.5 \text{ A}$ $I_{C} = 2 \text{ A}$ | V _{CE} = 5 V V _{CE} = 5 V V _{CE} = 5 V | 10 10 8 | | 50 | |
| tr tf ts | RESISTIVE LOAD Rise Time Fall Time Storage Time group A group B | $V_{CC} = 125 V$ $I_{B1} = 0.4 A$ $t_p = 30 \ \mu s$ | Ic = 2 A I _{B2} = -0.2 A | 1.4 | 0.7 0.3 | 0.5 2.1 2.75 | μs μs μs μs |
| t _s t _f | INDUCTIVE LOAD Storage Time Fall Time | $I_{C} = 1 A$ $V_{BE} = -5 V$ $V_{clamp} = 300 V$ | I _{B1} = 0.2 A L = 50 mH | | 0.8 0.10 | | μs μs |
| VF | Diode Forward Voltage | I _C = 1 A | | | | 2.5 | V |

* Pulsed: Pulse duration = 300 μs, duty cycle 1.5 % Note : Product is pre-selected in storage time (GROUP A and GROUP B). STMicroelectronics reserves the right to ship either groups according to production availability. Please contact your nearest STMicroelectronics sales office for delivery details.

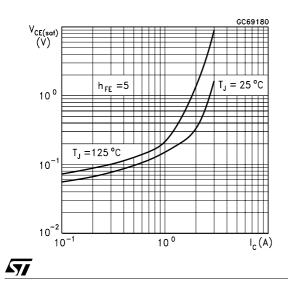
Safe Operating Areas



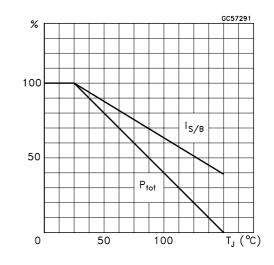
DC Current Gain



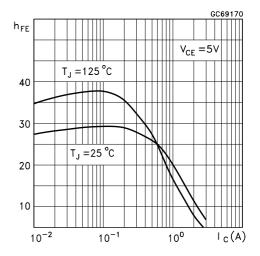
Collector Emitter Saturation Voltage



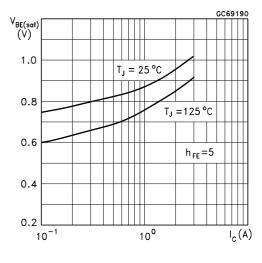
Derating Curve



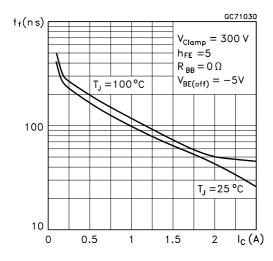
DC Current Gain



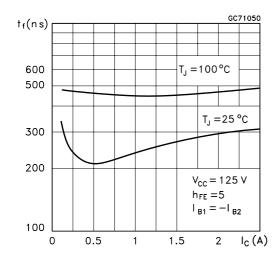




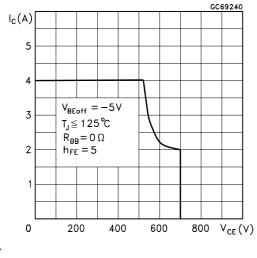
Inductive Fall Time



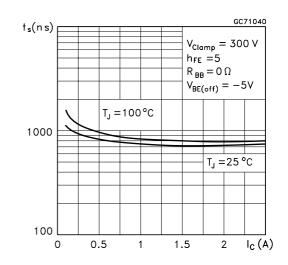
Resistive Fall Time

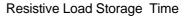


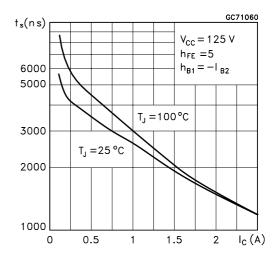
Reverse Biased SOA



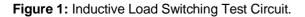
Inductive Storage Time







4/7



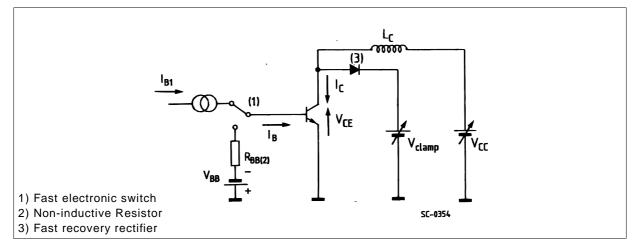
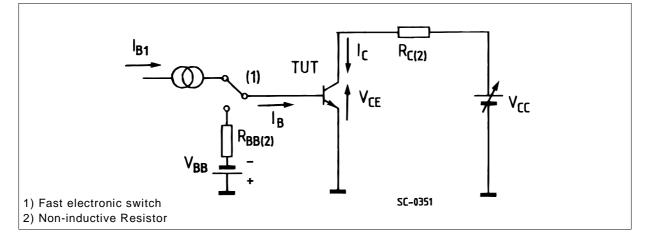


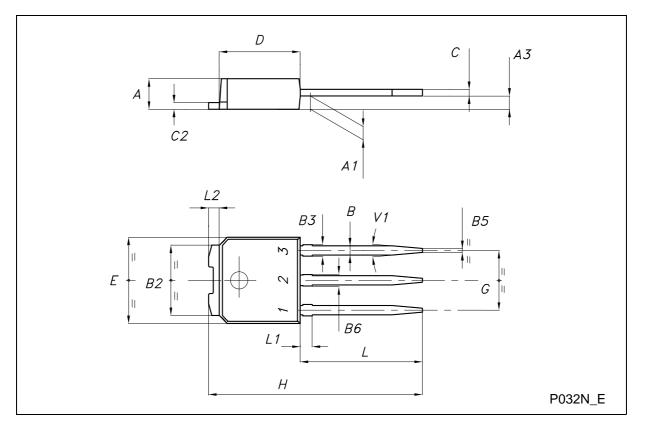
Figure 2: Resistive Load Switching Test Circuit.



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| DIM. | mm | | | inch | | | |
|------|-------|------|-------|-------|-------|-------|--|
| | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. | |
| А | 2.20 | | 2.40 | 0.087 | | 0.094 | |
| A1 | 0.90 | | 1.10 | 0.035 | | 0.043 | |
| A3 | 0.70 | | 1.30 | 0.028 | | 0.051 | |
| В | 0.64 | | 0.90 | 0.025 | | 0.035 | |
| B2 | 5.20 | | 5.40 | 0.204 | | 0.213 | |
| B3 | | | 0.85 | | | 0.033 | |
| B5 | | 0.30 | | | 0.012 | | |
| B6 | | | 0.95 | | | 0.037 | |
| С | 0.45 | | 0.60 | 0.018 | | 0.024 | |
| C2 | 0.48 | | 0.60 | 0.019 | | 0.024 | |
| D | 6.00 | | 6.20 | 0.237 | | 0.244 | |
| Е | 6.40 | | 6.60 | 0.252 | | 0.260 | |
| G | 4.40 | | 4.60 | 0.173 | | 0.181 | |
| Н | 15.90 | | 16.30 | 0.626 | | 0.642 | |
| L | 9.00 | | 9.40 | 0.354 | | 0.370 | |
| L1 | 0.80 | | 1.20 | 0.031 | | 0.047 | |
| L2 | | 0.80 | 1.00 | | 0.031 | 0.039 | |

TO-251 (IPAK) MECHANICAL DATA



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